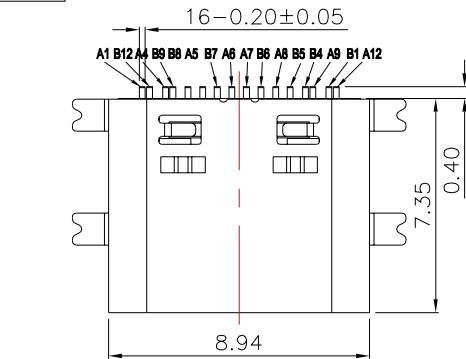
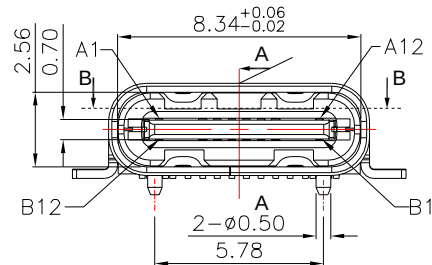
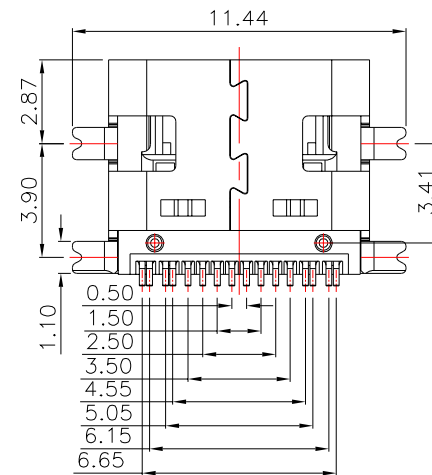
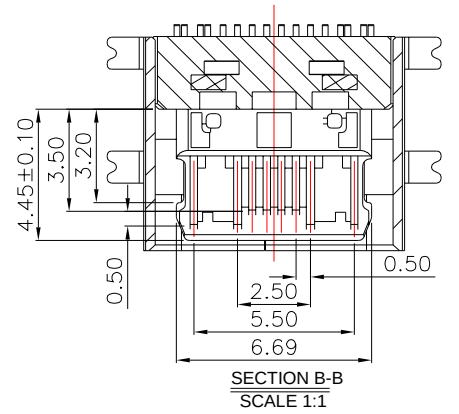


A1	GND	B12	GND
A4	VBUS	B9	VBUS
A5	CC1	B8	SBU2
A6	DP1	B7	DN2
A7	DN1	B6	DP2
A8	SBU1	B5	CC2
A9	VBUS	B4	VBUS
A12	GND	B1	GND
PIN	SIGNAL NAME	PIN	SIGNAL NAME

NOTE:

1.MATERIAL SPECIFICATION:

- 1.HOUSING:LCP,UL94 V-0.
- 2.CONTACTS:COPPER ALLOY
- 3.MID PLATE: STAINLESS STEEL

2.PLATING SPECIFICATION:

2-1.CONTACTS:

- Ni 50u" MIN. UNDER PLATED OVER ALL.
- Au PLATED ON THE FUNCTIONAL AREA OF CONTACT.
- (GOLD PLATING THICKNESS FOLLOW THE P/N)
- GOLD FLASH PLATING ON SOLDER AREA

2-2.FRONT SHELL:

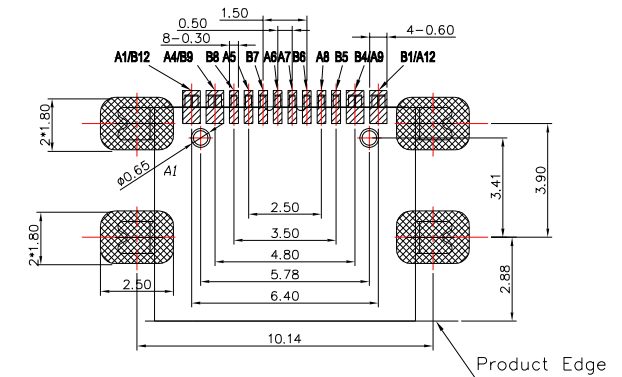
- Ni 30u" MIN. UNDER PLATED OVER ALL.

3.MECHANICAL PERFORMANCE,

- 3-1.INSERTION FORCE: 5~20N.
- 3-2.REMOVAL FORCE: 8~20N.
- 3-3.DURABILITY: 10000 CYCLES.

4.ELECTRICAL PERFORMANCE,

- 4-1. CURRENT RATING:5A
 - VOLTAGE RATING:20V
 - 4-2.INSULATION RESISTANCE: 100MΩ MIN
 - 4-3.DIELECTRIC WITHSTAND VOLTAGE,AC 100V FOR 1 MINUTE.
 - 4-4.LOW CONTACT RESISTANCE: INITIAL 40MΩ
 - AFTER 50MΩ
5. ENVIRONMENTAL PERFORMANCE:
- OPERATING TEMPERATURE: -30°C~+85°C.



RECOMMEND P.C.B LAYOUT(COMPONENT SIDE)
TOLERANCE FOR PCB LAYOUT IS ± 0.05

APPROVALS			DATE					
DRAWN								
CHECKED					TITLE:			
APPROVALS					PART NO.	22		
D.	TOLERANCES ARE		30~	±0.30	ANGLE	UNIT: mm	SCALE: 1:1	PROJ: 
			10~30	±0.25				
			5~10	±0.20				
			~ 5	±0.15				
			±2'	DRAWING NO.		SHEET 1 OF 1		

ECN NO.	REV.	DATE.	DESCRIPTION.	CHANGE.	CHECK.	APPRO.
	A		NEW			